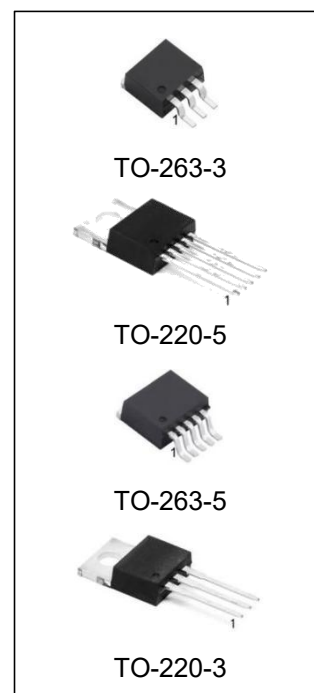


## 3A Low-Voltage Low-Dropout Regulator

### FEATURES

- 3A minimum guaranteed output current
- 500mV typical dropout at 3A
- Ideal for 3.0V to 2.5V conversion
- Ideal for 2.5V to 1.8V or 1.5V conversion
- 1% initial accuracy
- Low ground current
- Current limiting and thermal shutdown
- Reversed-battery protection
- Reversed-leakage protection
- Fast transient response
- TTL/CMOS compatible enable pin => MIC39301
- Error flag output - MIC39301 only
- Adjustable version - MIC39302 only
- TO-263 and TO-220 packaging
- Moisture Sensitivity Level 3



### ORDERING INFORMATION

DEVICE	Package Type	MARKING	Packing	Packing Qty
MIC39300T-1.5	TO-220-3	MIC39300-1.5	TUBE	1000pcs/box
MIC39300T-1.8	TO-220-3	MIC39300-1.8	TUBE	1000pcs/box
MIC39300T-2.5	TO-220-3	MIC39300-2.5	TUBE	1000pcs/box
MIC39300T-3.3	TO-220-3	MIC39300-3.3	TUBE	1000pcs/box
MIC39300T-5.0	TO-220-3	MIC39300-5.0	TUBE	1000pcs/box
MIC39300S-1.5/TR	TO-263-3	MIC39300-1.5	REEL	500pcs/reel
MIC39300S-1.8/TR	TO-263-3	MIC39300-1.8	REEL	500pcs/reel
MIC39300S-2.5/TR	TO-263-3	MIC39300-2.5	REEL	500pcs/reel
MIC39300S-3.3/TR	TO-263-3	MIC39300-3.3	REEL	500pcs/reel
MIC39300S-5.0/TR	TO-263-3	MIC39300-5.0	REEL	500pcs/reel
MIC39301T-1.5	TO-220-5	MIC39301-1.5	TUBE	1000pcs/box
MIC39301T-1.8	TO-220-5	MIC39301-1.8	TUBE	1000pcs/box
MIC39301T-2.5	TO-220-5	MIC39301-2.5	TUBE	1000pcs/box
MIC39301T-3.3	TO-220-5	MIC39301-3.3	TUBE	1000pcs/box
MIC39301T-5.0	TO-220-5	MIC39301-5.0	TUBE	1000pcs/box
MIC39301S-1.5/TR	TO-263-5	MIC39301-1.5	REEL	500pcs/reel
MIC39301S-1.8/TR	TO-263-5	MIC39301-1.8	REEL	500pcs/reel
MIC39301S-2.5/TR	TO-263-5	MIC39301-2.5	REEL	500pcs/reel
MIC39301S-3.3/TR	TO-263-5	MIC39301-3.3	REEL	500pcs/reel
MIC39301S-5.0/TR	TO-263-5	MIC39301-5.0	REEL	500pcs/reel
MIC39302T	TO-220-5	MIC39302	TUBE	1000pcs/box
MIC39302S/TR	TO-263-5	MIC39302	REEL	500pcs/reel

## DESCRIPTION

The MIC39300, MIC39301 and MIC39302 are 3.0A low-dropout linear voltage regulators that provide a low voltage, high-current output with a minimum of external components.

The MIC39300/1 offers extremely low dropout (typically 400mV at 3.0A) and low ground current (typically 36mA at 3.0A).

The MIC39300/1/2 is ideal for PC add-in cards that need to convert from standard 5V or 3.3V down to new, lower core voltages. A guaranteed maximum dropout voltage of 500mV over all operating conditions allows the MIC39300/1/2 to provide 2.5V from a supply as low as 3V.

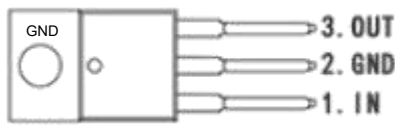
The MIC39300/1/2 also has fast transient response for heavy switching applications. The device requires only 47μF of output capacitance to maintain stability and achieve fast transient response. The MIC39300/1 is fully protected with over current limiting, thermal shutdown, reversed-battery protection, reversed-leakage protection, and reversed-lead insertion. The MIC39301 offers a TTL-logic compatible enable pin and an error flag that indicates under voltage and over current conditions. Offered in fixed voltages, the MIC39300/1/2 comes in the TO-220 and TO-263 packages and is an ideal upgrade to older, NPN-based linear voltage regulators.

## APPLICATIONS

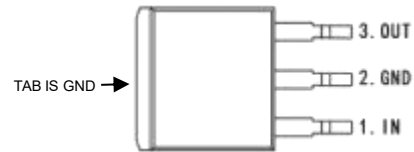
- LDO linear regulator for PC add-in cards
- High-efficiency linear power supplies
- Multimedia and PC processor supplies
- SMPS post regulator
- Low-voltage microcontrollers
- StrongARM™ processor supply

## PIN CONFIGURATION

### MIC39300-XX

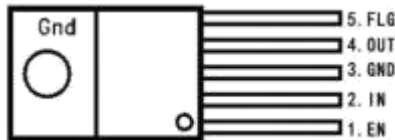


TO-220-3

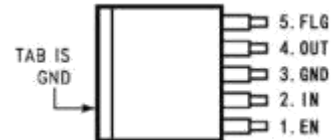


TO-263-3

### MIC39301-XX

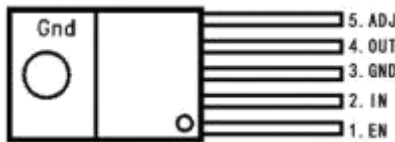


TO-220-5

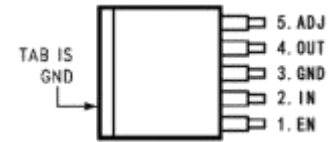


TO-263-5

### MIC39302



TO-220-5

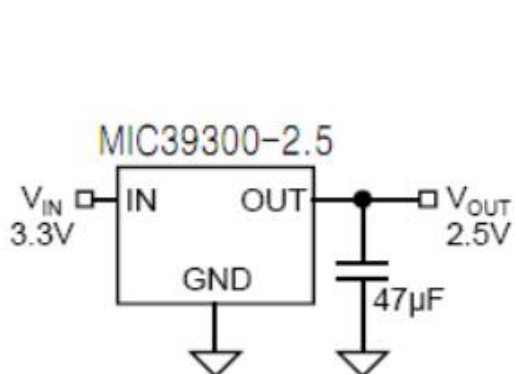


TO-263-5

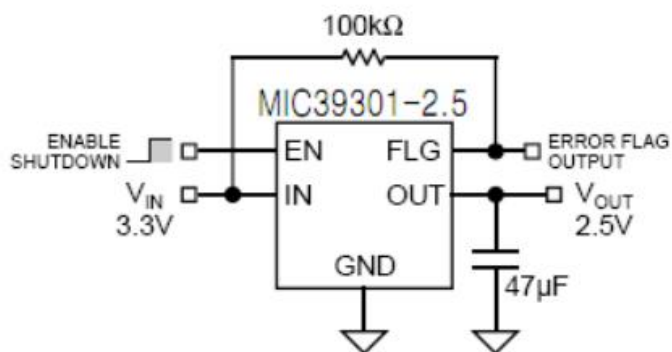
## PIN DESCRIPTION

Pin Number			PIN Name	DESCRIPTION
MIC39300-XX	MIC39301-XX	MIC39302		
-	1	1	Enable (Input)	CMOS-compatible control input. Logic high = enable, Logic low or open = Shutdown
1	2	2	IN	Supply (Input): +16V maximum supply
2	3	3	GND	Ground pin and TAB are internally connected.
3	4	4	OUT	Regulator Output
-	5	-	FLG	Flag (Output): Open-collector error flag output.
-	-	5	ADJ	Adjustment Input: Feedback input.

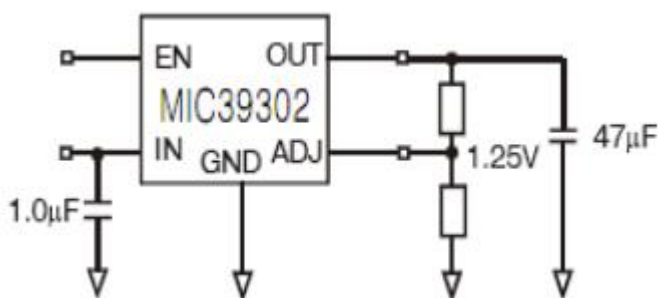
## TYPICAL APPLICATION CIRCUIT



**MIC39300**



**MIC39301**



**MIC39302**

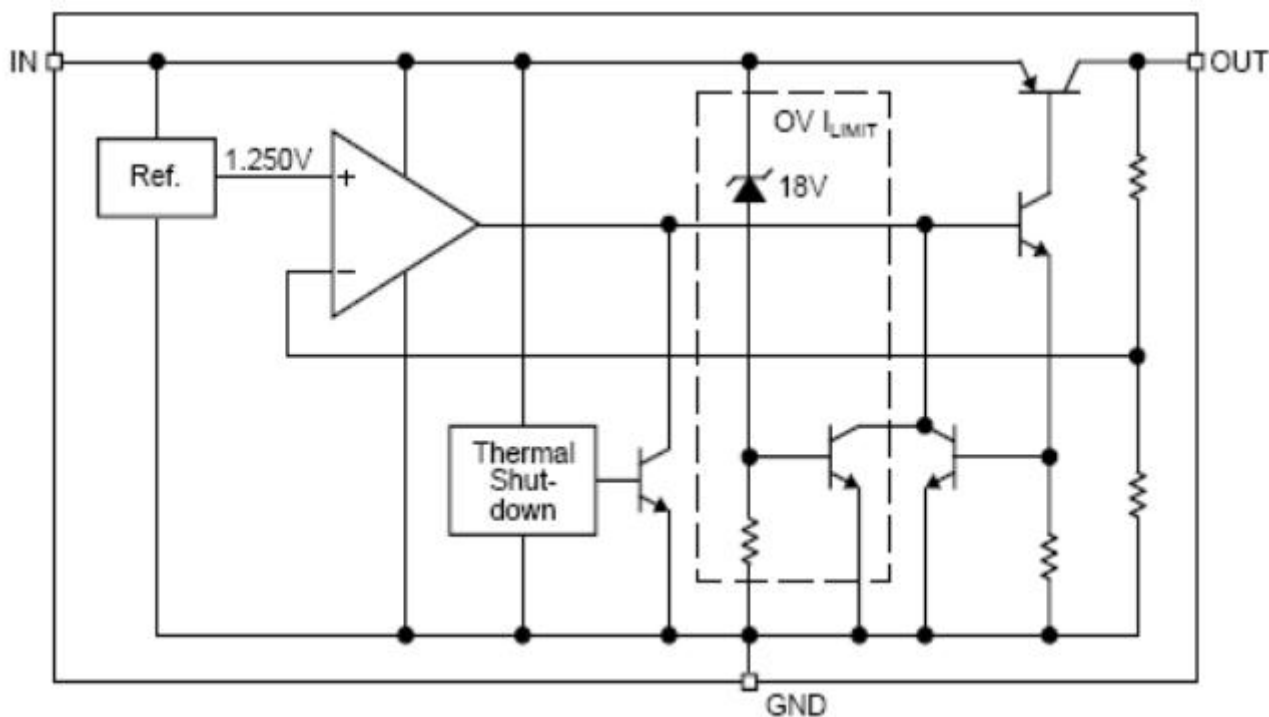
## ABSOLUTE MAXIMUM RATINGS (Note 1)

Condition	Min	Max	UNITS
Supply Voltage (VIN)	-20	+20	V
Enable Voltage(VEN)	-	+20	V
Storage Temperature (TS)	-65	+150	°C
Lead Temperature(soldering, 10 sec)	-	245	°C
ESD,	Note 3		-

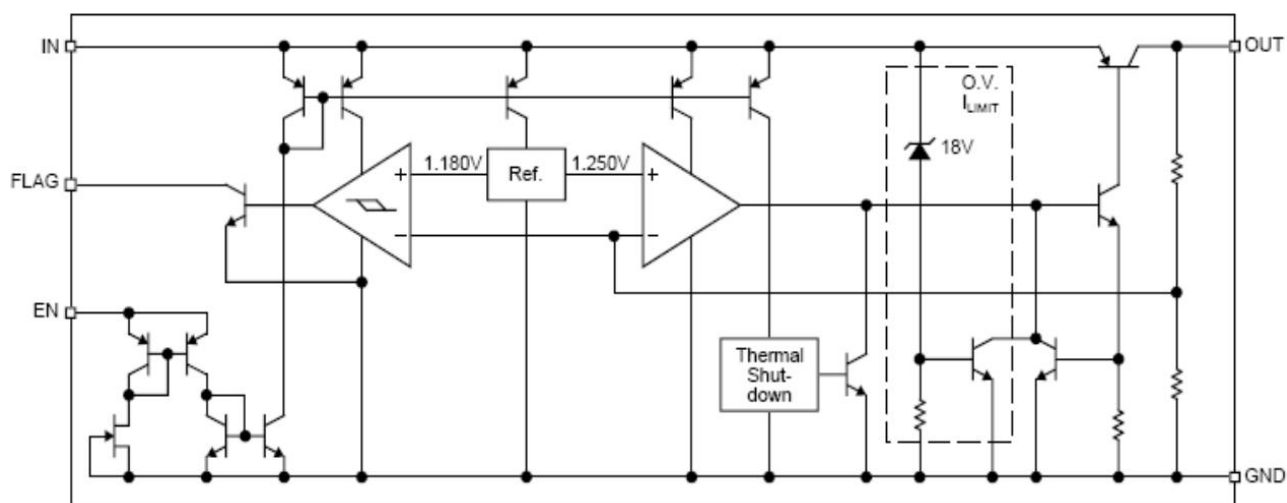
## OPERATING RATINGS (Note 2)

Condition	Min	Max	UNITS
Supply Voltage (VIN)	-2.25	+16	V
Enable Voltage(VEN)	-	+16	V
Maximum Power Dissipation (PD(max))	Note 4		-
Operating Temperature (Ta)	-40	+125	°C
Package Thermal Resistance	TO263(θ <sub>JC</sub> )	5	°C/W
	TO220(θ <sub>JC</sub> )	2	°C/W

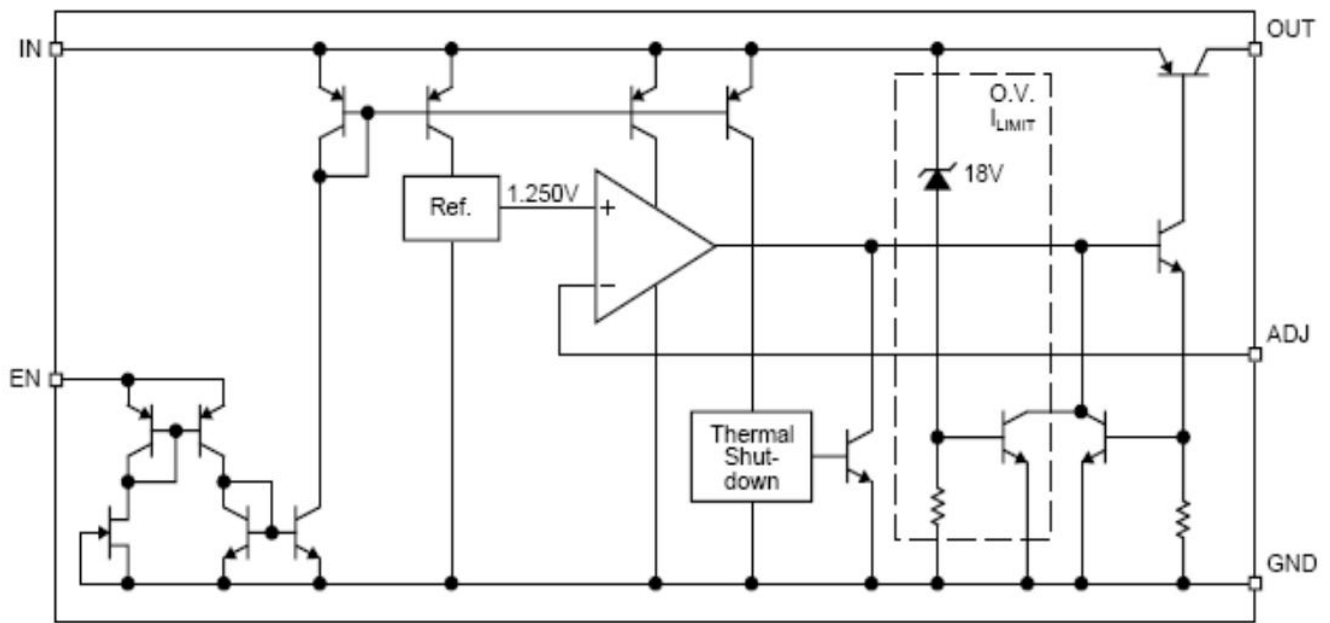
## BLOCK DIAGRAM



MIC39300 Fixed (1.5V,1.8V,2.5V,3.3V,5.0V)



MIC39301 Fixed with flag and enable



MIC39302 Adjustable

## ELECTRICAL CHARACTERISTICS

$T_a=25^{\circ}\text{C}$ , **bold values** Indicate  $-40^{\circ}\text{C} \leq T_a \leq 125^{\circ}\text{C}$ ; unless noted

Symbol	Parameter	Condition	Min	Typ	Max	Units
V <sub>OUT</sub>	Output Voltage	10mA	-1		1	%
		$10\text{mA} \leq I_{\text{OUT}} \leq 3\text{A}, V_{\text{OUT}}+1\text{V} \leq V_{\text{IN}} \leq 8\text{V}$	<b>-2</b>		<b>2</b>	%
	Line Regulation	$I_{\text{OUT}}=10\text{mA}, V_{\text{OUT}}+1\text{V} \leq V_{\text{IN}} \leq 8\text{V}$		0.06	0.5	%
	Load Regulation	$V_{\text{IN}}=V_{\text{OUT}}+1\text{V}, 10\text{mA}$		0.2	1	%
$\Delta V_{\text{OUT}}/\Delta T$	Output Voltage Temp.Coefficient, <b>Note 5</b>			<b>20</b>	<b>100</b>	ppm/ $^{\circ}\text{C}$
V <sub>DO</sub>	Dropout Voltage, <b>Note 6</b>	$I_{\text{OUT}}=100\text{mA}, \Delta V_{\text{OUT}}=-1\%$		80	<b>200</b>	mV
		$I_{\text{OUT}}=750\text{mA}, \Delta V_{\text{OUT}}=-1\%$		200		mV
		$I_{\text{OUT}}=1.5\text{A}, \Delta V_{\text{OUT}}=-1\%$		320		mV
		$I_{\text{OUT}}=3\text{A}, \Delta V_{\text{OUT}}=-1\%$		400	<b>550</b>	mV
I <sub>GND</sub>	Ground Current, <b>Note 7</b>	$I_{\text{OUT}}=750\text{mA}, V_{\text{IN}}=V_{\text{OUT}}+1\text{V}$		10	<b>20</b>	mA
		$I_{\text{OUT}}=1.5\text{A}, V_{\text{IN}}=V_{\text{OUT}}+1\text{V}$		17		mA
		$I_{\text{OUT}}=3\text{A}, V_{\text{IN}}=V_{\text{OUT}}+1\text{V}$		45		mA
I <sub>GND(do)</sub>	Dropout Ground Pin Current	$V_{\text{IN}} \leq V_{\text{OUT}}(\text{nominal})-0.5\text{V}, I_{\text{OUT}}=10\text{mA}$		6		mA
I <sub>OUT(lim)</sub>	Current Limit	$V_{\text{OUT}}=0\text{V}, V_{\text{IN}}=V_{\text{OUT}}+1\text{V}$		4.5		A

Enable Output (MIC39301)						
V <sub>EN</sub>	Enable Input Voltage	logic low (off)			<b>0.8</b>	V
		logic low (on)	<b>2.25</b>			V
I <sub>IN</sub>	Enable Input Current	V <sub>EN</sub> =V <sub>IN</sub>		15	30	μA
					<b>75</b>	μA
		V <sub>EN</sub> =0.8V			2	μA
					<b>4</b>	μA
I <sub>OUT(shdn)</sub>	Shunt down Output Current	<b>Note 8</b>		10	<b>20</b>	μA
Flag Output(MIC39301)						
I <sub>FLG(leak)</sub>	Output Leakage Current	V <sub>OH</sub> =16V		0.01	1	μA
					<b>2</b>	μA
V <sub>FLG(do)</sub>	Output Low Voltage	V <sub>IN</sub> =2.250V, I <sub>OL</sub> , 250μA, <b>Note 9</b>		220	300	mV
					<b>400</b>	mV
V <sub>FLG</sub>	Low Threshold	% of V <sub>OUT</sub>	93			%
	High Threshold				99.2	%
	Hysteresis			1		%
MIC39302 Only						
	Reference Voltage	<b>Note 10</b>	1.238	1.250	1.262	V
			<b>1.225</b>		<b>1.275</b>	V
			<b>1.231</b>		<b>1.277</b>	v
	Adjust Pin Bias Current			40	80	nA
					<b>120</b>	nA
	Reference Voltage Temp.Coefficient	<b>Note 7</b>		20		ppm/°C
	Adjust Pin Bias Current Temp.Coefficient			0.1		nA/°C

Note 1. Exceeding the absolute maximum ratings may damage the device.

Note 2. The device is not guaranteed to function outside its operating rating.

Note 3. Devices are ESD sensitive. Handling precautions recommended.

Note 4. PD(max) = (TJ(max) – TA) θJA, where θJA depends upon the printed circuit layout. See “Applications Information.”

Note 5. Vout temperature coefficient is ΔV<sub>OUT</sub>(worst case) (TJ(max) – TJ(min)) where TJ(max) is +125°C and TJ(min) is 0°C

Note 6. VDO = V<sub>IN</sub> – V<sub>OUT</sub> when V<sub>OUT</sub> decreases to 99% of its nominal output voltage with V<sub>IN</sub> = V<sub>OUT</sub> + 1V.

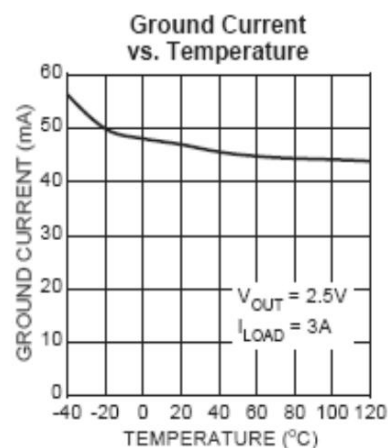
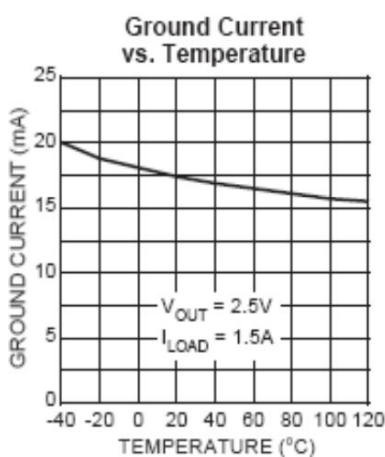
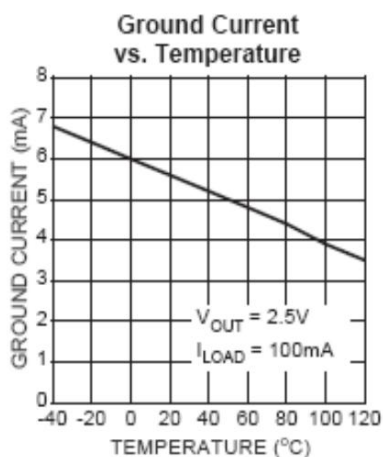
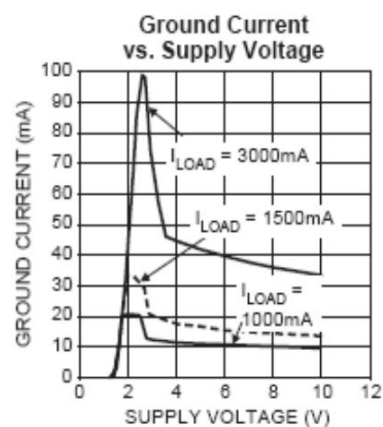
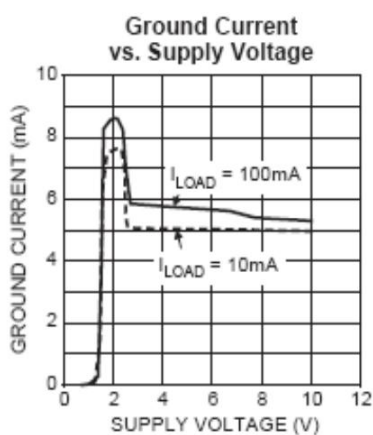
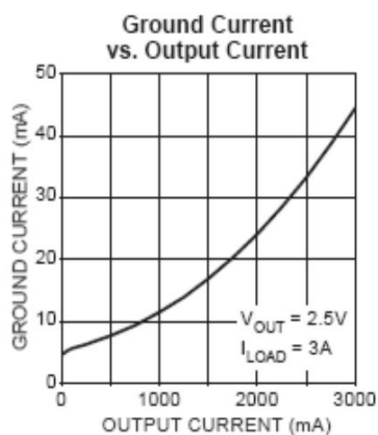
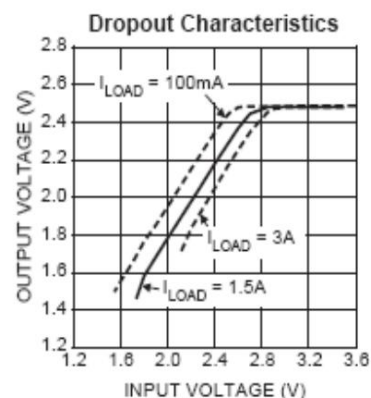
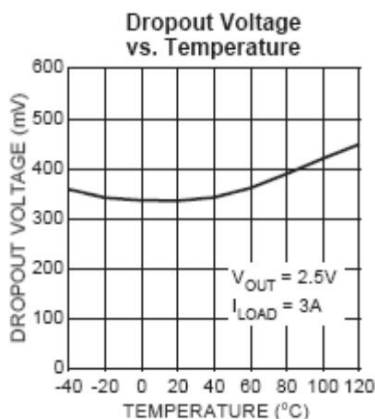
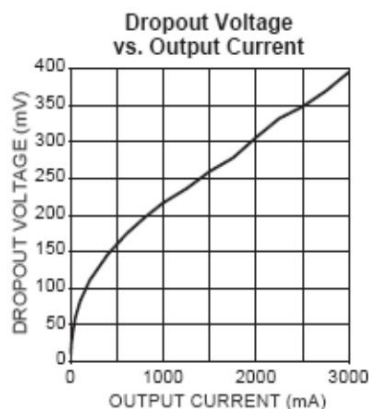
Note 7. I<sub>GND</sub> is the quiescent current. I<sub>IN</sub> = I<sub>GND</sub> + I<sub>OUT</sub>.

Note 8. V<sub>EN</sub> 0.8V, V<sub>IN</sub> 8V, and V<sub>OUT</sub> = 0V

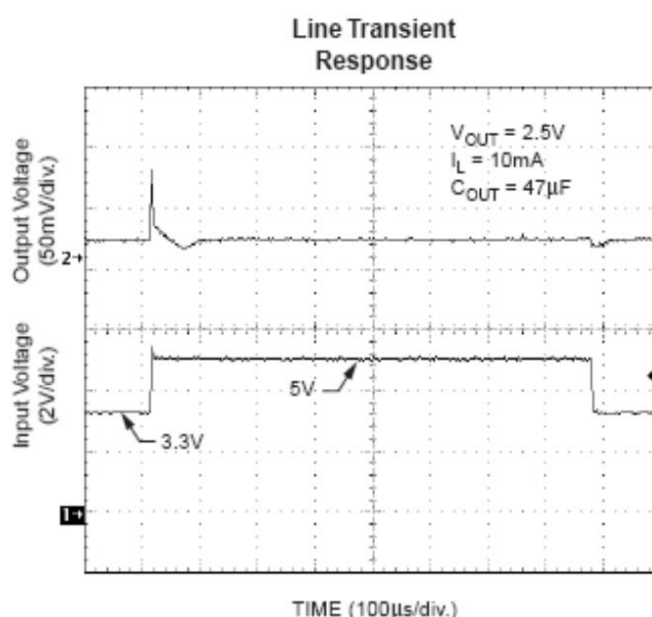
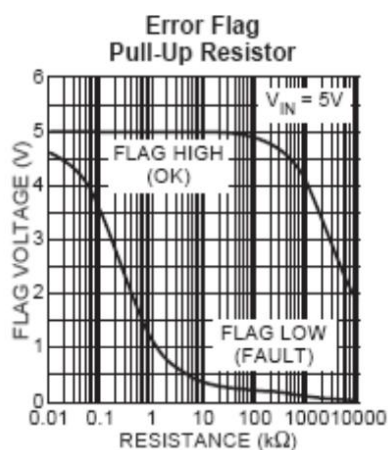
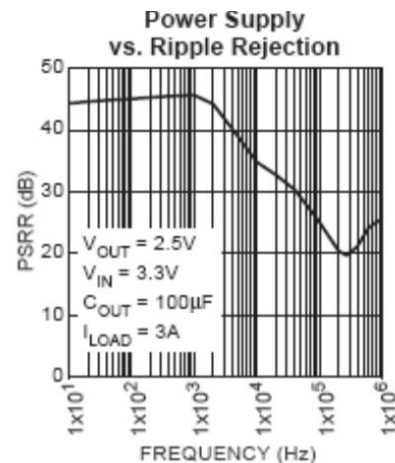
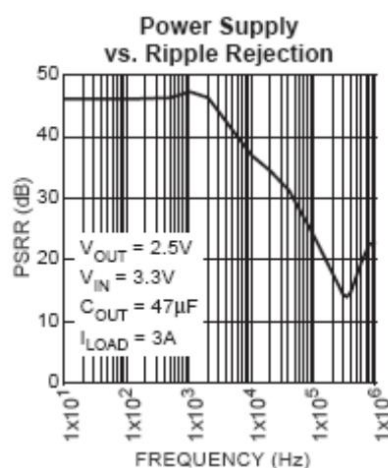
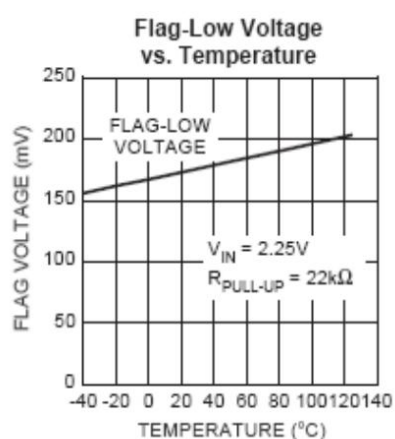
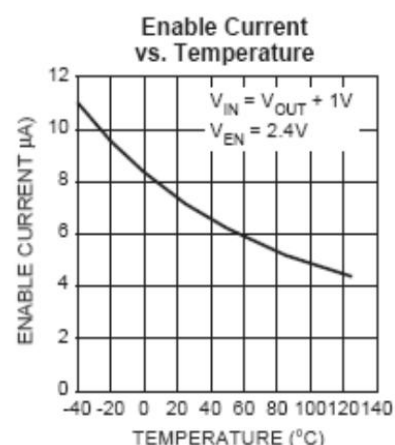
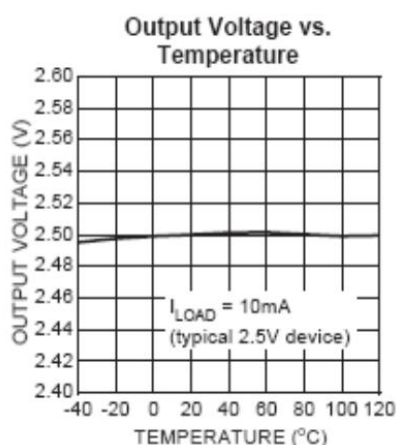
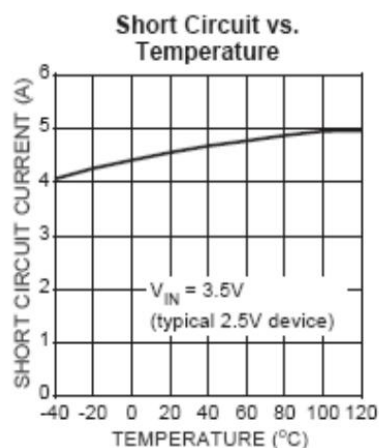
Note 9. For a 2.5V device, V<sub>IN</sub> = 2.250V (device is in dropout).

Note 10. V<sub>REF</sub> ≤ V<sub>OUT</sub> ≤ (V<sub>IN</sub> – 1V), 2.25V ≤ V<sub>IN</sub> ≤ 16V, 10mA ≤ I<sub>L</sub> ≤ 3A, TJ = T<sub>MAX</sub>.

## TYPICAL PERFORMANCE CHARACTERISTICS





**TYPICAL PERFORMANCE CHARACTERISTICS**


## APPLICATION INFORMATION

The MIC39300/1 is a high-performance low-dropout voltage regulator suitable for moderate to high-current voltage regulator applications. Its 500mV dropout voltage at full load makes it especially valuable in battery-powered systems and as a high-efficiency noise filter in post-regulator applications. Unlike older NPN-pass transistor designs, where the minimum dropout voltage is limited by the base-to-emitter voltage drop and collector-to-emitter saturation voltage, dropout performance of the PNP output of these devices is limited only by the low V<sub>CE</sub> saturation voltage. A trade-off for the low dropout voltage is a varying base drive requirement. The MIC39300/1/2 regulator is fully protected from damage due to fault conditions. Current limiting is provided. This limiting is linear output current during overload conditions is constant. Thermal shutdown disables the device when the die temperature exceeds the maximum safe operating temperature. Transient protection allows device (and load) survival even when the input voltage spikes above and below nominal. The output structure of these regulators allows voltages in excess of the desired output voltage to be applied without reverse current flow.

## THERMAL DESIGN

Linear regulators are simple to use. The most complicated design parameters to consider are thermal characteristics. Thermal design requires four application-specific parameters:

- Maximum ambient temperature (T<sub>A</sub>)
- Output Current (I<sub>OUT</sub>)
- Output Voltage (V<sub>OUT</sub>)
- Input Voltage (V<sub>IN</sub>)
- Ground Current (I<sub>GND</sub>)

Calculate the power dissipation of the regulator from these numbers and the device parameters from this datasheet, where the ground current is taken from the data sheet.

$$PD = (V_{IN} - V_{OUT}) I_{OUT} + V_{IN} \cdot I_{GND}$$

The heat sink thermal resistance is determined by:

$$\theta_{SA} = (T_{JMAX} - T_A) / P_D - (\theta_{JC} + \theta_{CS})$$

where T<sub>J</sub> (max) 125°C and  $\theta_{CS}$  is between 0°C and 2°C/W.

The heat sink may be significantly reduced in applications where the minimum input voltage is known and is large compared with the dropout voltage. Use a series input resistor to drop excessive voltage and distribute the heat between this resistor and the regulator. The low dropout properties of Taelin regulators allow significant reductions in regulator power dissipation and the associated heat sink without compromising performance. When this technique is employed, a capacitor of at least 1.0F is needed directly between the input and regulator ground. Refer to Application Note 9 for further details and examples on thermal design and heat sink specification.

## OUTPUT CAPACITOR

The MIC39300/1/2 requires an output capacitor to maintain stability and improve transient response. Proper capacitor selection is important to ensure proper operation. The MIC39300/1/2 output capacitor selection is dependent upon the ESR (equivalent series resistance) of the output capacitor to maintain stability. When the output capacitor is 47 $\mu$ F or greater, the output capacitor should have less than 1 $\Omega$  of ESR. This will improve transient response as well as promote stability. Ultralow ESR capacitors, such as ceramic chip capacitors may promote instability. These very low ESR levels may cause an oscillation and/or under damped transient response. A low-ESR solid tantalum capacitor works extremely well and provides good transient response and stability over temperature. Aluminum electrolytics can also be used, as long as the ESR of the capacitor is < 1 $\Omega$ . The value of the output capacitor can be increased without limit. Higher capacitance values help to improve transient response and ripple rejection and reduce output noise.

## INPUT CAPACITOR

An input capacitor of 1F or greater is recommended when the device is more than 4 inches away from the bulk ac supply capacitance, or when the supply is a battery. Small, surface-mount, ceramic chip capacitors can be used for the bypassing. Larger values will help to improve ripple rejection by bypassing the input to the regulator, further improving the integrity of the output voltage. Transient Response and 3.3V.

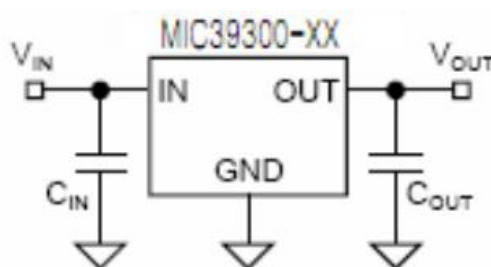


Fig 1. Capacitor Requirements

## MINIMUM LOAD CURRENT

The MIC39300/1/2 regulator is specified between finite loads.

If the output current is too small, leakage currents dominate and the output voltage rises.

A 10mA minimum load current is necessary for proper regulation.

## **TRANSIENT RESPONSE AND 3.3V TO 2.5V CONVERSION**

The MIC39300/1/2 has excellent transient response to variations in input voltage and load current. The device has been designed to respond quickly to load current variations and input voltage variations. Large output capacitors are not required to obtain this performance. A standard 47 $\mu$ F output capacitor, preferably tantalum, is all that is required.

Larger values help to improve performance even further. By virtue of its low-dropout voltage, this device does not saturate into dropout as readily as similar NPN-based designs. When converting from 3.3V to 2.5V, the NPN-based regulators are already operating in dropout, with typical dropout requirements of 1.2V or greater. To convert down to 2.5V without operating in dropout, NPN-based regulators require an input voltage of 3.7V at the very least. The MIC39300/1/2 regulator will provide excellent performance with an input as low as 3.0V. This gives the PNP-based regulators a distinct advantage over older, NPN-based linear regulators.

## **ERROR FLAG**

The MIC39301 version features an error flag circuit which monitors the output voltage and signals an error condition when the voltage drops 5% below the nominal output voltage. The error flag is an open-collector output that can sink 10mA during a fault condition. Low output voltage can be caused by a number of problems, including an overcurrent fault (device in current limit) or low input voltage. The flag is inoperative during overtemperature shutdown.

## **ENABLE INPUT**

The MIC39301 version features an enable input for on/off control of the device. Its shutdown state draws “zero” current (only micro amperes of leakage). The enable input is TTL/ CMOS compatible for simple logic interface, but can be connected to up to 20V. When enabled, it draws approximately 15 $\mu$ A.

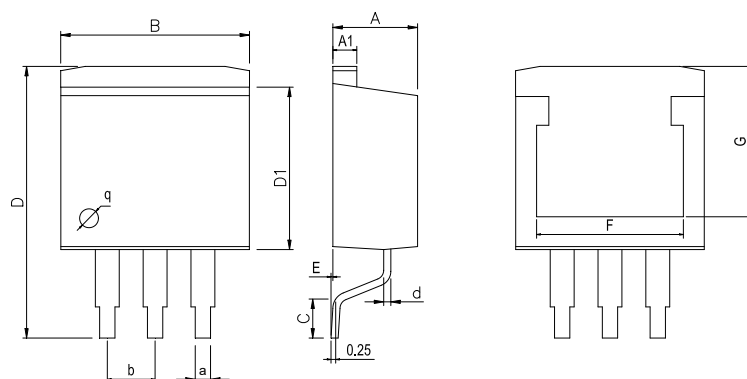
## **ADJUSTABLE REGULATOR DESIGN**

The MIC39302 allows programming the output voltage anywhere between 1.25V and the 16V maximum operating rating of the family. Two resistors are used. Resistors can be quite large, up to 1M $\Omega$ , because of the very high input impedance and low bias current of the sense comparator. The resistor values are calculated by :  **$R1=R2(V_{out}/1.250-1)$**

Where  $V_O$  is the desired output voltage. Figure 1 shows component definition. Applications with widely varying load currents may scale the resistors to draw the minimum load current required for proper operation (see below).

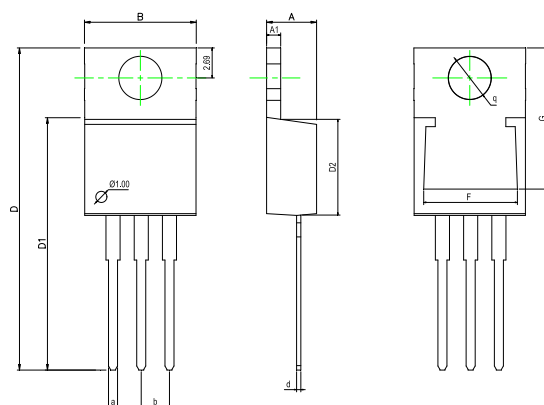
## PHYSICAL DIMENSIONS

### TO-263-3



Dimensions In Millimeters(TO-263-3)											
Symbol:	A	A1	B	C	D	D1	E	F	G	a	b
Min:	4.45	1.22	10	1.89	13.7	8.38	0	8.332	7.70	0.71	2.54BSC
Max:	4.62	1.32	10.4	2.19	14.6	8.89	0.305	8.552	8.10	0.97	

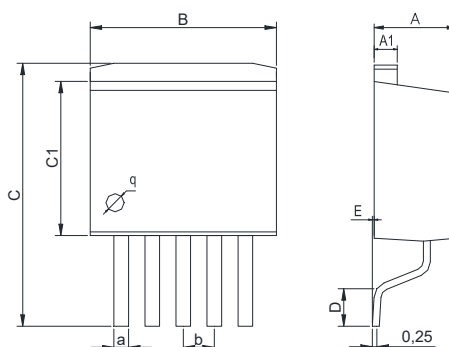
### TO-220-3



Dimensions In Millimeters(TO-220-3 )												
Symbol:	A	A1	B	D	D1	D2	F	G	a	d	b	q
Min:	4.45	1.22	10	28.2	22.22	8.50	8.30	12.55	0.71	0.33	2.54	3.80
Max:	4.62	1.32	10.4	28.9	22.62	9.10	8.55	12.75	0.97	0.42	BSC	TYP

# PHYSICAL DIMENSIONS

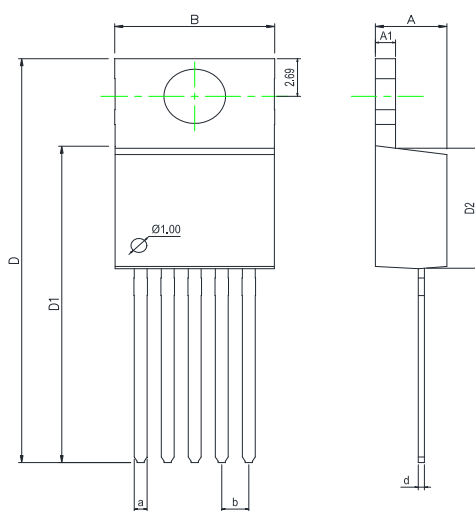
## TO-263-5



**Dimensions In Millimeters(TO-263-5)**

Symbol:	A	A1	B	C	C1	D	E	a	b
Min:	4.45	1.22	10	13.7	8.40	1.90	0	0.71	1.70BSC
Max:	4.62	1.32	10.4	14.6	8.90	2.10	0.20	0.97	

## TO-220-5



**Dimensions In Millimeters(TO-220-5 )**

Symbol:	A	A1	B	D	D1	D2	a	d	b
Min:	4.52	1.25	10	28.2	22.4	8.69	0.71	0.33	1.70BSC
Max:	4.62	1.29	10.3	28.9	22.6	8.79	0.97	0.42	

**REVISION HISTORY**

DATE	REVISION	PAGE
2018-8-15	New	1-16
2023-7-27	Modify the package dimension diagram TO-220-5 、 Update encapsulation type、 Update Lead Temperature、 Update PIN Configuration	14、 1、 4、 3

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